

30A 600V Fast Recovery Epitaxial Diode(FRED)

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Features

VOLTAGE	600 V
CURRENT	30A

- Ultrafast Recovery Time
- Soft Recovery Characteristics
- Low Forward Voltage
- Low stored Charge
- •Low Leakage Current
- Low Recovery Loss

1 2

PIN DESCRIPTION

TO-220AB

Mechanical Data

•Case: TO-220AB

- •Freewheeling, Snubber, Clamp
- Snubber Diode
- Switch Power Supplies
- Motor control
- Inverters Converters
- •PFC

9110					
Package	Part No.	ROHS Status	Packing		
T0-220AB	SI30U600	Pb-Free	Box (Tube)		

MAXIMUM RATINGS(T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	600	V
Maximum RMS voltage	V _{RMS}	420	V
Maximum DC blocking voltage	V_{DC}	600	V
Average Rectified Forward Current	I _{F(AV)}	30	Α
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	300	А
Operating Juniction Temperature	TJ	-55 to150	$^{\circ}$
Operating Junction and Storage Temperature Range	T _{STG}	-55 to150	$^{\circ}$



ELECTRICAL CHARACTERISTICS (T_A=25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	TYP	Max	Unit
Static Ch	Static Characteristics					
V_{BR}	Reverse Breakdown Voltage	I _R =50uA	600	-	-	V
V _F	Instantaneous forward	I _F =30A ,T _a =25 °C	-	1.9	2.5	V
VF	voltage per diode	I _F =15A ,Ta=125 °C	-	1.35	2.0	V
I _R	Reverse current per diode	V _R =600V,T _a =25 °C	-	-	2	uA
T. Deveres Deserver Time		I _F =0.5A, I _R =1A, I _{rr} =0.25A	-	26	35	ns
T _{rr}	Reverse Recovery Time	I _F =1A,V _R =30V, di/dt=-200A/us	-	24	-	ns

Remark:

- 1. Customer should obtain the latest version of datasheet before placing order, and verify the relevant information.
- 2. Cutting damage and chipping area can't beyond scribe line in given size range.
- 3. Testing system of Trr could be different, customer might take secondary test to evaluate if necessary.
- 4.Customer might choose the bonding wire material and diameter according to acutal sitatuation ,while no less than our recommendation.





Typical Operating Characteristics

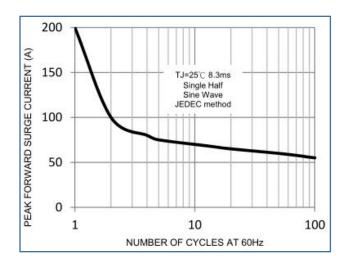


FIG.1-Maximum Non-Repetitive Forward Surge Current

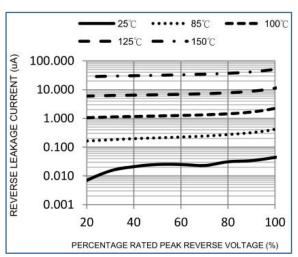


FIG.2-Typical Reverse Characteristics

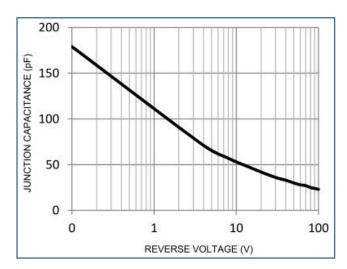


FIG.3 Typical Junction Capacitance

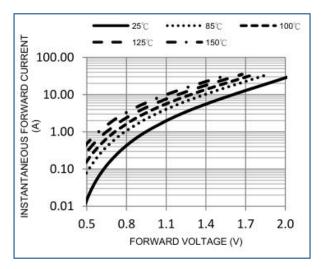
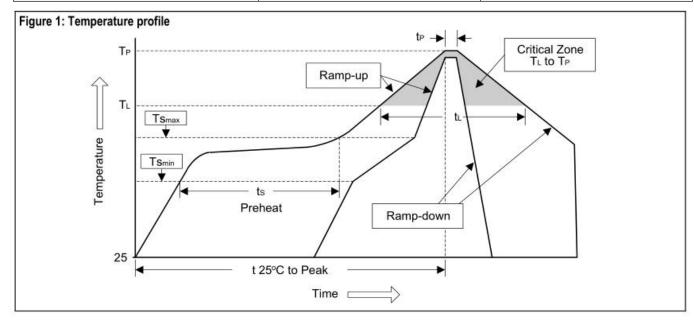


FIG.4 Typical Forward Characteristics



Soldering Methods for Products

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate(TL to TP)	<3℃/sec	<3℃/sec
Preheat		
-Temperature Min(Ts min)	100 ℃	150℃
-Temperature Max(Ts max)	150 ℃	200 ℃
-Time(min to max)(ts)	60 to 120 sec	60 to 180 sec
Ts max to TL		
- ramp-up rate	<3°C/sec	<3℃/sec
Time maintained above:		
-Temperature(TL)	183 ℃	217 ℃
-Time(t L)	60 to 150 sec	60 to 150 sec
Peak Temperature(T p)	240℃+0/-5℃	250℃+0/-5℃
Time within 5℃ of actual Peak	10 to 30 sec	20 to 40 sec
Temperature	10 to 30 sec	20 to 40 sec
Ramp-down Rate	<6°C/sec	<6℃/sec
Time 25 °C to Peak Temperature	<6 minutes	<8 minutes



Note :1.Storage environment: Temperature=10°C to 35@Humidity=45%±15%

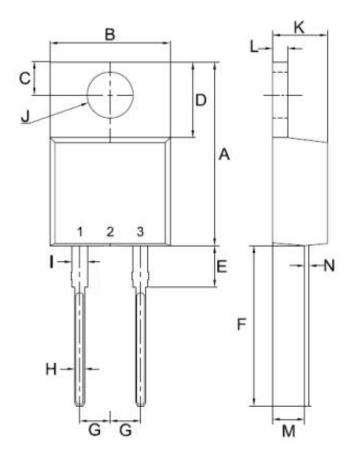
- 2. Reflow soldering of surface-mount devices
- 3.Flow(wave) soldering(solder dipping)

Products	Peak Temperature	Dipping Time
Pb devices	245 ℃ ±5 ℃	5sec±1sec
Pb-free devices	250℃+0/-5℃	5sec±1sec





Package Outline



	ΓO-22	0AB
	Unit:m	m
DIM	MIN	MAX
A	14.80	15. 80
В	9.57	10.57
С	2.54	2. 94
D	5.80	6. 80
Е	2.95	3. 95
F	12.70	13. 40
G	2.34	2. 74
Н	0.51	1.11
Ι	0.97	1. 57
J	3. 54 ø	4. 14¢
K	4. 27	4.87
L	1.07	1.47
M	2.03	2, 92
N	0.30	0.64





Important Notice

Si-Trend reserves the right to change all product `product specifications and data without prior notice; Our customer Please confirm to place an order confirmation before make the integrity of information complete and up-to-date •

Any semiconductor under specific conditions are possible to certain failure or malfunction rate; Customers are responsible in the use of Si-Trend products to system design and manufacturing in compliance with safety standards and adopting safety measures. To avoid the potential risk of failure may cause the personal safety and property loss.

Si-Trend Always refine on to provide more excellent products

Modify record

Date	Version	Description	Pagination
20170626	A.0	original	6